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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Yi-Shung CHAUG, *et al.*

Appl. No. 10/665,992

Filed: September 19, 2003

For: PROCESS FOR FORMING A  
PATTERNED THIN FILM  
STRUCTURE FOR IN-MOLD  
DECORATION

Art Unit: 1734

Confirmation No.: 5386

Examiner: Chan, Sing P

Attorney Docket: 07783.0101.CPUS01

**RESPONSE TO FINAL OFFICE ACTION**

**MAIL STOP: AF**

Commissions for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

This is in response to the Final Office Action dated May 16, 2006, and is submitted within two months of the mailing date of the Final Office Action. The Examiner is requested to enter the amendments and reconsider the application.

The U.S. Patent and Trademark Office is hereby authorized to charge any fee deficiency, including fees under §1.17; or credit any overpayment, to our Deposit Account No. 08-3038 referencing Atty. Dkt. No. 07783.0101.CPUS01.